

C0805X331K1GACTU

Aliases (C0805X331K1GAC7800) SMD Comm COG Flex, Ceramic, 330 pF, 10%, 100 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 0805, 0.6 mm



Click here for the 3D model.

General Information		
Series	SMD Comm COG Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra- Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	11 mg	
Shelf Life	78 Weeks	
MSL	1	

0% Loss/Decade Hour

100 GOhms

	Specifications	
0805	Capacitance	330 pF
2mm +/-0.3mm	Measurement Condition	1 MHz 1.0Vrms
1.25mm +/-0.3mm	Tolerance	10%
0.78mm +/-0.20mm	Voltage DC	100 VDC
0.6mm MIN	Dielectric Withstanding Voltage	250 VDC
0.5mm +/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC) Dissipation Factor 0.1	
4000		0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions Chip Size

Packaging

Packaging Specifications

Packaging Quantity

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